



## Description

### JMT P-channel Enhancement Mode Power MOSFET

#### Features

- $V_{DS} = -40V$ ,  $I_D = -70A$
- $R_{DS(ON)} < 10m\Omega$  @  $V_{GS} = -10V$
- $R_{DS(ON)} < 15m\Omega$  @  $V_{GS} = -4.5V$
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead free product is acquired

#### Application

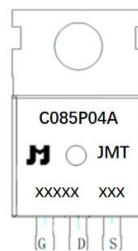
- PWM Applications
- Load Switch
- Power Management



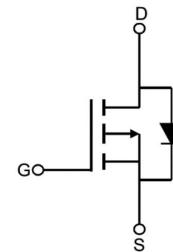
100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



TO-220C-3L top view



Marking and pin Assignment



Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	OUTLINE	Device Package	TUBE (PCS)	Inner Box (PCS)	Per Carton (PCS)
JMTC085P04A	JMTC085P04A	TUBE	TO-220C-3L	50	1000	5000

## Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise specified)

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		-40	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	-70	A
		$T_C = 100^\circ C$	-46	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>		-280	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>note2</sup>		324	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ C$	108	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.4	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +175	$^\circ C$

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

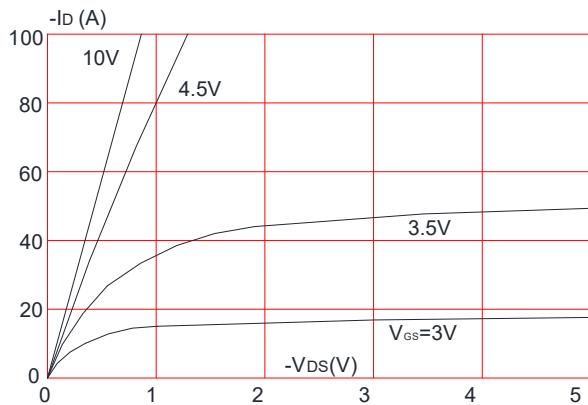
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D = -250\mu\text{A}$	-40	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = -40\text{V}$ , $V_{GS}=0\text{V}$	-	-	-1	$\mu\text{A}$
$I_{GSS}$	Gate to Body Leakage Current	$V_{DS}=0\text{V}$ , $V_{GS}= \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D = -250\mu\text{A}$	-1.0	-1.5	-2.5	V
$R_{DS(\text{on})}$ note3	Static Drain-Source on-Resistance	$V_{GS} = -10\text{V}$ , $I_D = -30\text{A}$	-	8	10	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}$ , $I_D = -20\text{A}$	-	11	15	
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = -20\text{V}$ , $V_{GS}=0\text{V}$ , $f=1.0\text{MHz}$	-	7200	-	pF
$C_{oss}$	Output Capacitance		-	625	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	437	-	pF
$Q_g$	Total Gate Charge	$V_{DS} = -20\text{V}$ , $I_D = -20\text{A}$ , $V_{GS} = -10\text{V}$	-	115	-	nC
$Q_{gs}$	Gate-Source Charge		-	23	-	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	20	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = -20\text{V}$ , $I_D = -20\text{A}$ , $V_{GS} = -10\text{V}$ , $R_{\text{GEN}} = 3\Omega$	-	15	-	ns
$t_r$	Turn-on Rise Time		-	88	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	122	-	ns
$t_f$	Turn-off Fall Time		-	101	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current	-	-	-70	-	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-280	-	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_s = -30\text{A}$	-	-	-1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{GS}=0\text{V}$ , $I_s = -20\text{A}$ , $dI/dt = 100\text{A}/\mu\text{s}$	-	25	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	17	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

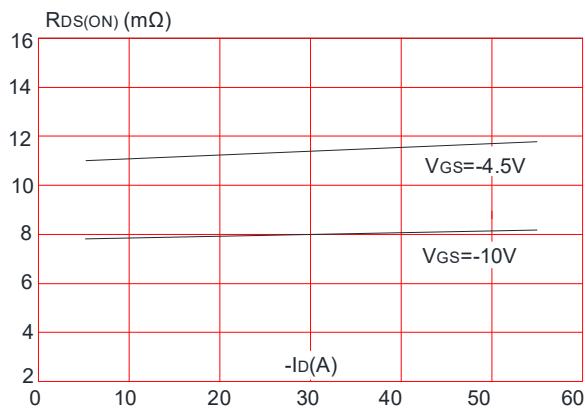
2. EAS condition:  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = -20\text{V}$ ,  $V_G = -10\text{V}$ ,  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = -36\text{A}$ 3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

## Typical Performance Characteristics

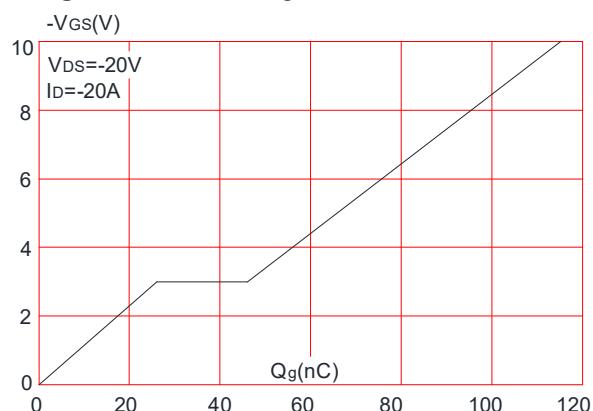
**Figure 1:** Output Characteristics



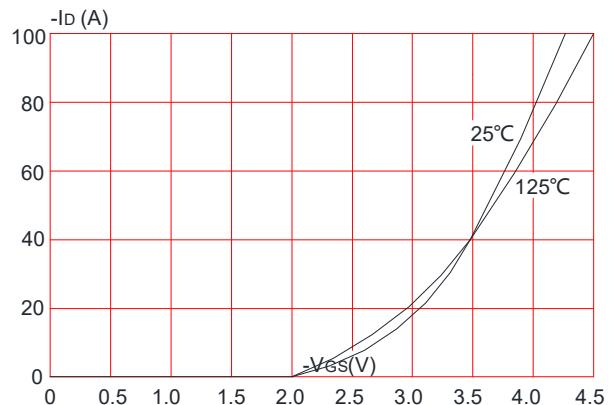
**Figure 3:** On-resistance vs. Drain Current



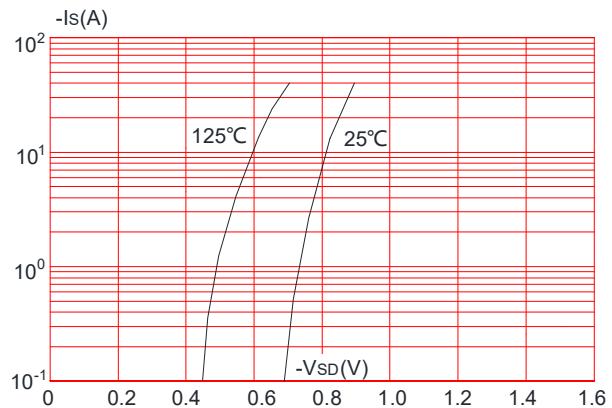
**Figure 5:** Gate Charge Characteristics



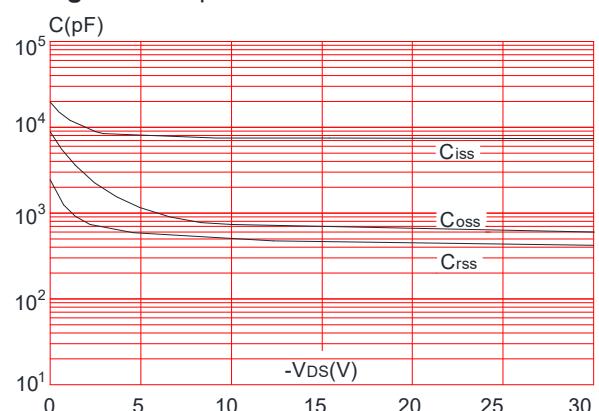
**Figure 2:** Typical Transfer Characteristics



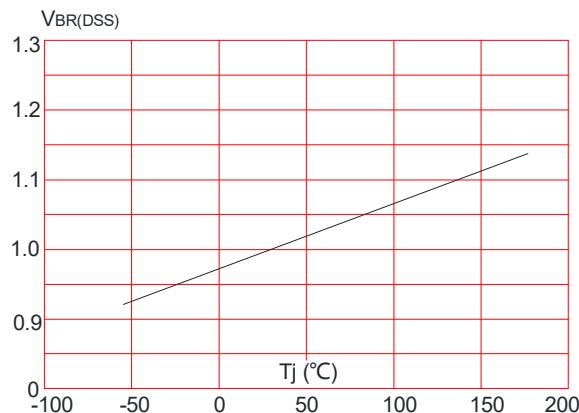
**Figure 4:** Body Diode Characteristics



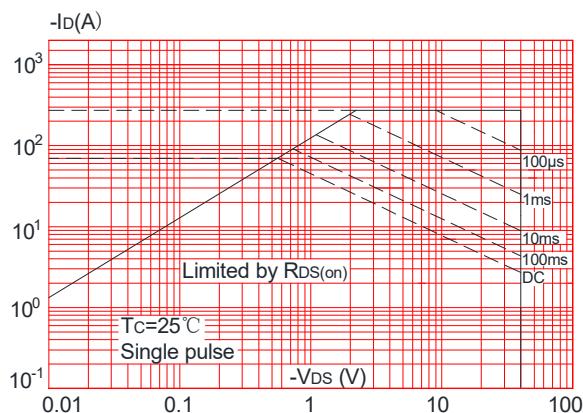
**Figure 6:** Capacitance Characteristics



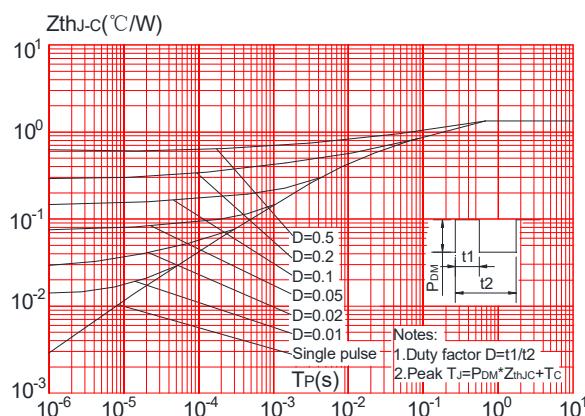
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



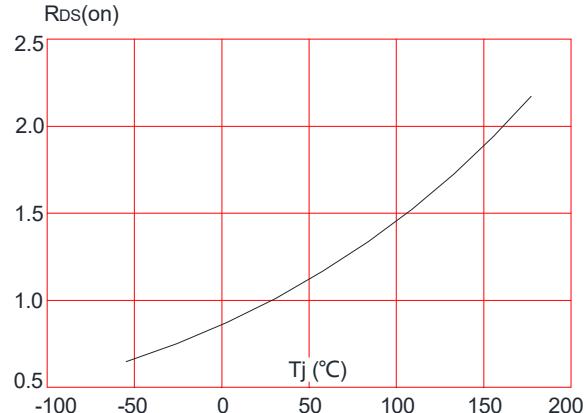
**Figure 9:** Maximum Safe Operating Area



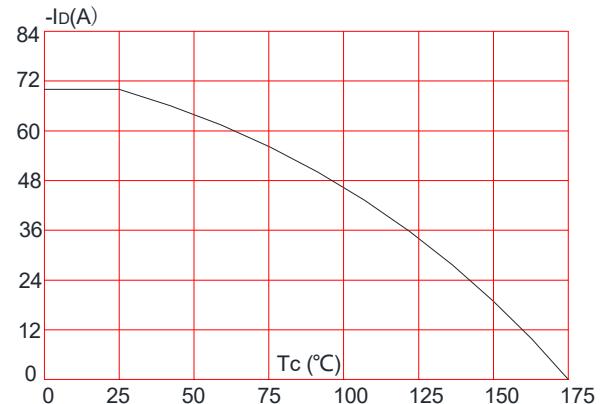
**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



**Figure 8:** Normalized on Resistance vs. Junction Temperature

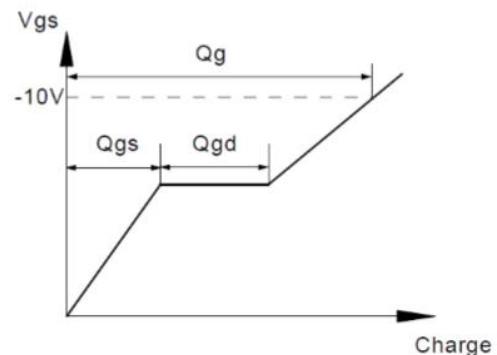
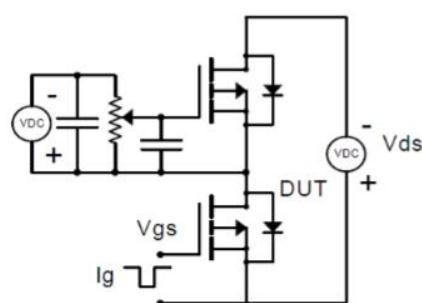


**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature

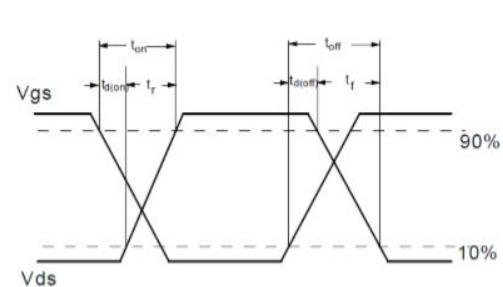
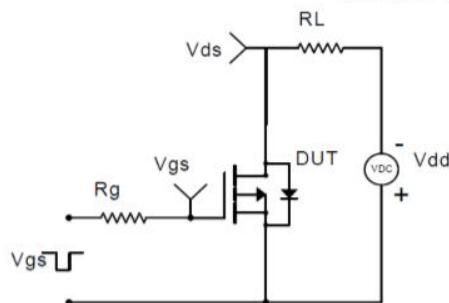


## Test Circuit

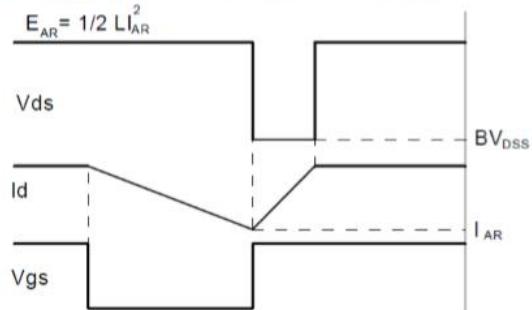
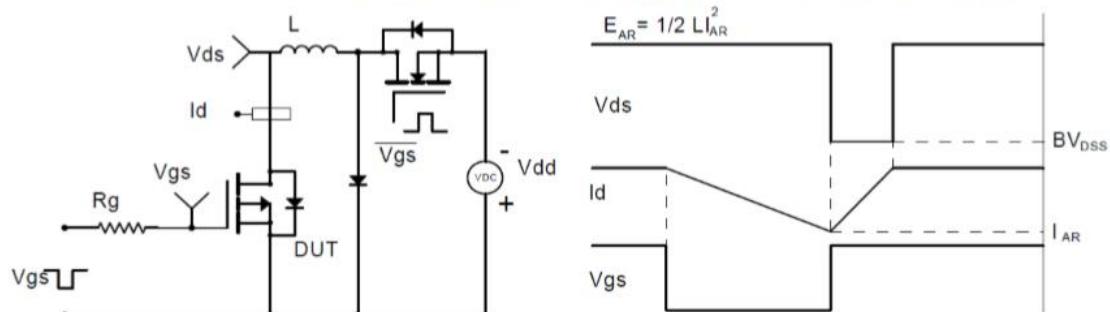
Gate Charge Test Circuit & Waveform



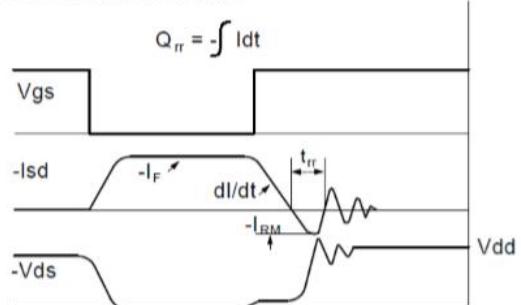
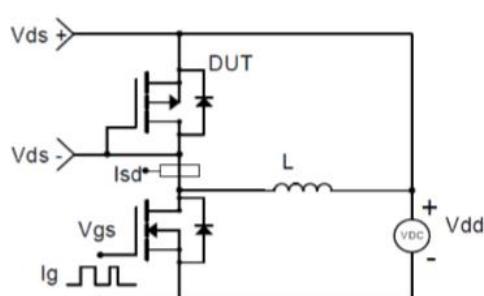
Resistive Switching Test Circuit & Waveforms



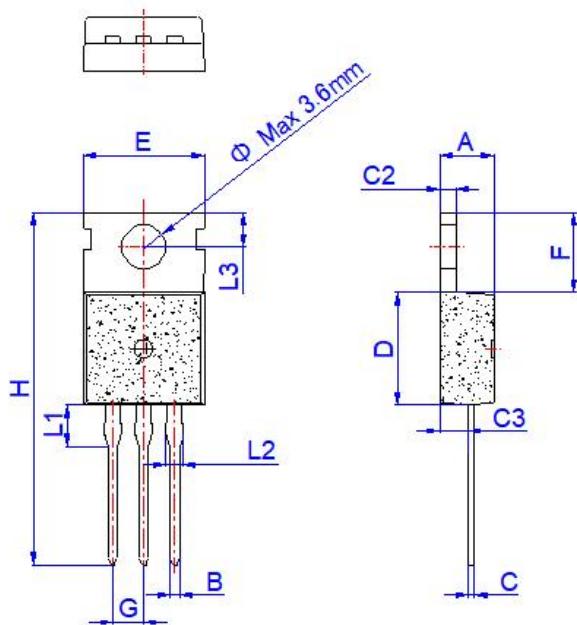
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



## Package Mechanical Data-TO-220C-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
Φ		3.6			0.142	

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